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INTERNATIONAL STANDARD

IEEE Std 1650™

Test methods for measurement of electrical properties of carbon nanotubes



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**TEST METHODS FOR MEASUREMENT OF ELECTRICAL PROPERTIES
OF CARBON NANOTUBES**

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IEEE Standard Test Methods for Measurement of Electrical Properties of Carbon Nanotubes

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Nanotechnology Council Standards Committee
of the
IEEE Nanotechnology Council

Approved 8 December 2005

IEEE-SA Standards Board

Abstract: Recommended methods and standardized reporting practices for electrical characterization of carbon nanotubes (CNTs) are covered. Due to the nature of CNTs, significant measurement errors can be introduced if the electrical characterization design-of-experiment is not properly addressed. The most common sources of measurement error, particularly for high-impedance electrical measurements commonly required for CNTs, are described. Recommended practices in order to minimize and/or characterize the effect of measurement artifacts and other sources of error encountered while measuring CNTs are given.

Keywords: carbon nanotube, electrical characterization, high-impedance measurement, nanotechnology

IEEE Introduction

This standard covers recommended methods and standardized reporting practices for electrical characterization of carbon nanotubes (CNTs). Due to the nature of CNTs, significant measurement errors can be introduced if not properly addressed. This standard describes the most common sources of measurement error, and gives recommended practices in order to minimize and/or characterize the effect of each error.

Standard reporting practices are included in order to minimize confusion in analyzing reported data. Disclosure of environmental conditions and sample size are included so that results can be appropriately assessed by the research community. These reporting practices also support repeatability of results, so that new discoveries may be confirmed more efficiently. The practices in this standard were compiled from scientists and engineers from the CNT field. These practices were based on standard operating procedures utilized in facilities worldwide. This standard was initiated in 2003 to assist in the diffusion of CNT technology from the laboratory into the marketplace. Standardized characterization methods and reporting practices creates a means of effective comparison of information and a foundation for manufacturing readiness.

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TEST METHODS FOR MEASUREMENT OF ELECTRICAL PROPERTIES OF CARBON NANOTUBES

1. Overview

1.1 Scope

This standard provides methods for the electrical characterization of carbon nanotubes (CNTs). The methods will be independent of processing routes used to fabricate the CNTs.

1.2 Purpose

There is currently no defined standard for the electrical characterization of CNTs and the means of reporting performance and other data. Without openly defined standard test methods, the acceptance and diffusion of CNT technology will be severely impeded. This standard is intended to provide and suggest procedures for characterization and reporting of data. These methods will enable the creation of a suggested reporting standard that will be used by research through manufacturing as the technology is developed. Moreover, the standards will recommend the necessary tools and procedures for validation.

1.3 Electrical characterization overview

1.3.1 Testing apparatus

Testing shall be performed using an electronic device test system with measurement sensitivity sufficient to give a measurement resolution of at least $\pm 0.1\%$ (minimum sensitivity at or better than three orders of magnitude below expected signal level). For example, the smallest current through a CNT can be on the order of 1 pA (10^{-12} A) or smaller. Therefore, in this case the instrument shall have a resolution of 100 aA (10^{-16} A) or smaller. Additionally, due to the various impedances encountered in nanoscale measurements, the input impedance of all elements of the test system shall be at least three orders of magnitude greater than the highest impedance in the device. Commercial semiconductor characterization systems with the capability to characterize CNT materials and devices typically have input impedance values of 10^{15} Ω to 10^{16} Ω , which is a recommended suitable range.

This test method requires that the instrumentation be calibrated against a known and appropriate set of standards [e.g., National Institute of Standards and Technology (NIST)]. These calibrations may be